Medical Catheter Wire Stripping – Polyimide / Enamel Wires

Introduction

The latest advances in electrophysiology require packing ever more sensors and wires into ever smaller packages. Polyimide (also called enamel) type insulations offer the highest density of interconnects due to the thin, tough insulation. Wire gages of 42 AWG to 50 AWG are now commonplace, with applications for wires smaller than 50 AWG now appearing. These wires are tough to strip. There are only 2 real options: mechanically scraping or hot caustic dipping. The former presents a challenge for small gages due to damage of the conductor and the latter is not preferred due to safety issues and residues. Even standard laser stripping with carbon dioxide lasers is not a solution as the long wavelength of the light means that a microscopic residue is left which cannot be soldered to.

Solution

Our Odyssey UV laser technology offers a gentle yet powerful method for the removal of polyimide type insulations. The short wavelength of the ultra-violet light coupled with nanosecond duration pulses enables the enamel to be instantly vaporized. By tuning the energy of the laser pulses, it is possible to completely remove the enamel whilst leaving a clean metallic surface for soldering. The process is gentle enough to leave thin plating layers such as gold, silver or tin without removing them.

Unlike older gas-based excimer technology which is very expensive to purchase and run, the Odyssey systems utilize modern solid-state laser technology which has no dangerous consumable gases. Also utilizing “direct write” technology means that strip patterns can be directly programmed via the user interface and there is no need for cumbersome masking and imaging of the laser beam.
Pre-cut wires, such as those protruding from the catheter handle, can be stripped directly using an **Odyssey-4 stripping system**. Wires can also be automatically stripped directly from a spool and then either re-spooled or cut to length. Alternatively, LWS can perform this process for you in its ISO9001 accredited production facility.

By controlling the laser pulse energy, it is also possible to laser cut these fine wires with the same laser source – meaning a convenient and accurate method for controlling strip length.
The same laser technology can be used to cleanly cut a wire.

A number of specialist wire manufacturers are able to create multi-filar ribbon cables which can be highly convenient in a device design if it is possible to strip windows in the ribbon cable for direct bonding to flex cables or PCBs. This is something that can only be achieved with advanced laser stripping technology. To make an ideal connection it is necessary to selectively strip one wire without impinging on adjacent wires. Moreover, it is often convenient to laser cut the wires to further aid the soldering process.